

Precision Low Dropout Linear Controllers

FEATURES

- Precision 1% Reference
- Over-Current Sense Threshold Accurate to 5%
- Programmable Duty-Ratio Over-Current Protection
- 4.5 V to 36 V Operation
- 100mA Output Drive, Source, or Sink
- Under-Voltage Lockout

Additional Features of the UC2832 series:

- Adjustable Current Limit to Current Sense Ratio
- Separate +V_{IN} terminal
- Programmable Driver Current Limit
- Access to V_{REF} and E/A(+)
- Logic-Level Disable Input

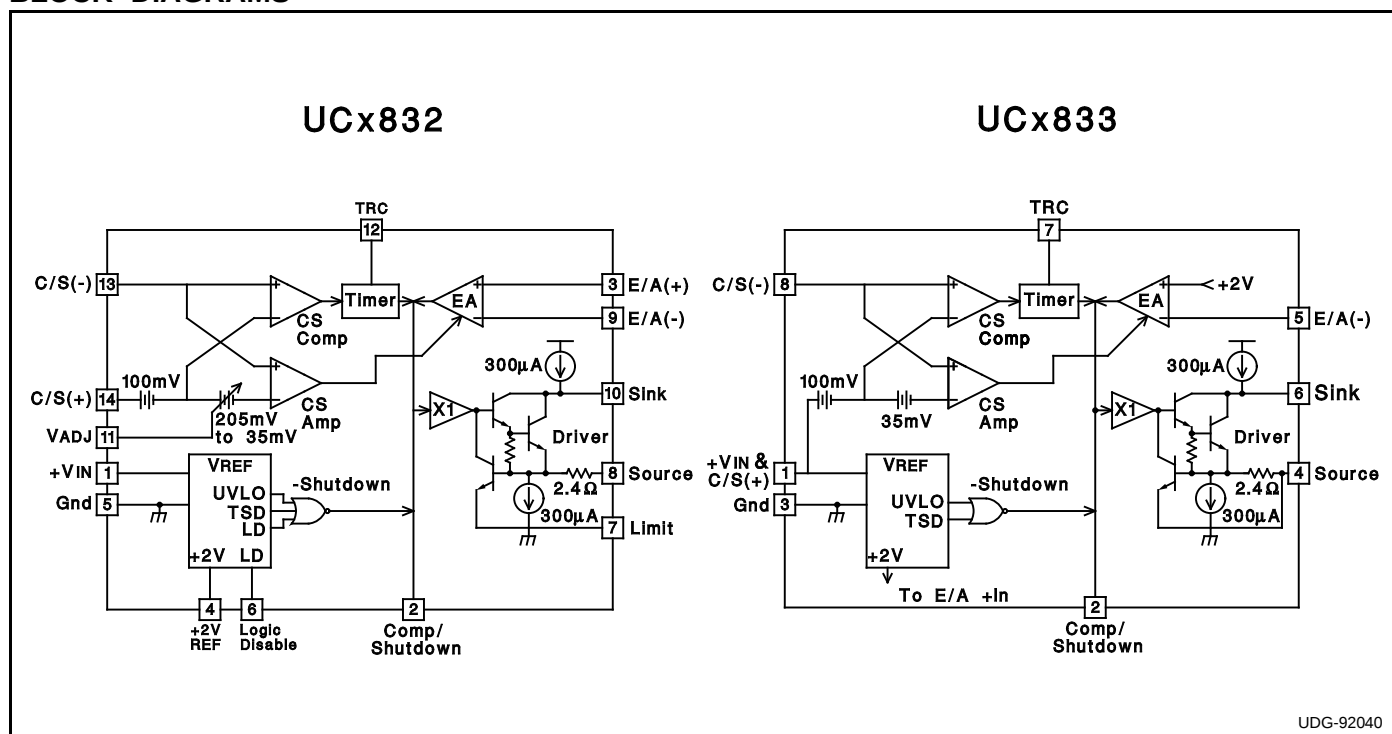
DESCRIPTION

The UC2832 and UC3833 series of precision linear regulators include all the control functions required in the design of very low dropout linear regulators. Additionally, they feature an innovative duty-ratio current limiting technique which provides peak load capability while limiting the average power dissipation of the external pass transistor during fault conditions. When the load current reaches an accurately programmed threshold, a gated-astable timer is enabled, which switches the regulator's pass device off and on at an externally programmable duty-ratio. During the on-time of the pass element, the output current is limited to a value slightly higher than the trip threshold of the duty-ratio timer. The constant-current-limit is programmable on the UCx832 to allow higher peak current during the on-time of the pass device. With duty-ratio control, high initial load demands and short circuit protection may both be accommodated without extra heat sinking or foldback current limiting. Additionally, if the timer pin is grounded, the duty-ratio timer is disabled, and the IC operates in constant-voltage/constant-current regulating mode.

These IC's include a 2 Volt ($\pm 1\%$) reference, error amplifier, UVLO, and a high current driver that has both source and sink outputs, allowing the use of either NPN or PNP external pass transistors. Safe operation is assured by the inclusion of under-voltage lockout (UVLO) and thermal shutdown.

The UC3833 family includes the basic functions of this design in a low-cost, 8-pin mini-dip package, while the UC2832 series provides added versatility with the availability of 14 pins. Packaging options include plastic (N suffix), or ceramic (J suffix). Specified operating temperature ranges are: commercial (0°C to 70°C), order UC3832/3 (N or J); and industrial (-40°C to 85°C), order UC2832/3 (N or J). Surface mount packaging is also available.

BLOCK DIAGRAMS



UDG-92040

ABSOLUTE MAXIMUM RATINGS

Supply Voltage +VIN	40V
Driver Output Current (Sink or Source)	450mA
Driver Sink to Source Voltage	40V
TRC Pin Voltage	-0.3V to 3.2V
Other Input Voltages	-0.3V to +VIN
Operating Junction Temperature (note 2)	-55°C to +150°C
Storage Temperature	-65°C to +150°C
Lead Temperature (Soldering, 10 Seconds)	300°C

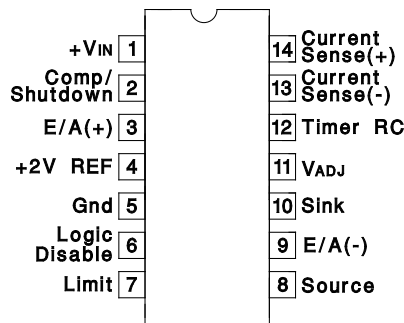
Note 1: Unless otherwise indicated, voltages are referenced to ground and currents are positive into, negative out of, the specified terminals.

Note 2: See Unitorde Integrated Circuits databook for information regarding thermal specifications and limitations of packages.

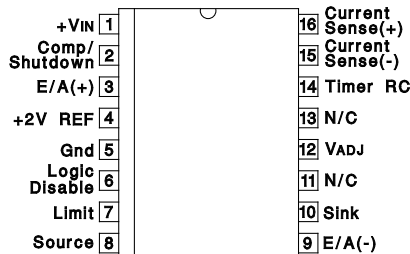
CONNECTION DIAGRAMS

UC2832

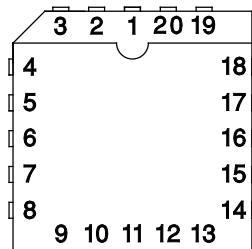
DIL-14 (Top View) J Or N Package



SOIC-16 (Top View) DW Package



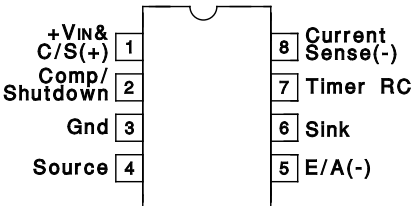
LCC-20 & PLCC-20 L & Q Package (Top View)



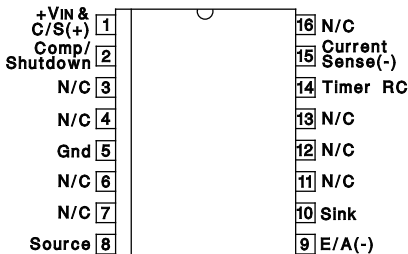
PACKAGE PIN FUNCTION	
FUNCTION	PIN
N/C	1
+VIN	2
Comp/Shutdown	3
E/A(+)	4
+2V REF	5
N/C	6
Gnd	7
Logic Disable	8
Limit	9
Source	10
N/C	11
E/A(-)	12
Sink	13
VADJ	14
N/C	15-17
Timer RC	18
Current Sense(-)	19
Current Sense(+)	20

UC3833

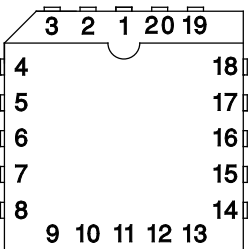
DIL-8 (Top View) J Or N Package



SOIC-16 (Top View) DW Package



LCC-20 & PLCC-20 L & Q Package (Top View)



PACKAGE PIN FUNCTION	
FUNCTION	PIN
+VIN & C/S(+)	1
N/C	2
N/C	3
N/C	4
Comp/Shutdown	5
Gnd	6
N/C	7
N/C	8
N/C	9
Source	10
N/C	11
E/A(-)	12
N/C	13
N/C	14
Sink	15
Timer RC	16
Current Sense(+)	17
N/C	18-20

ELECTRICAL CHARACTERISTICS: Unless otherwise stated, specifications hold for
TA = 0°C to 70°C for the UC3832/3, -40°C to 85°C
for the UC2832/3, +VIN = 15V, Driver sink = +VIN, C/S(+) voltage = +VIN. TA=TJ.

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Input Supply					
Supply Current	+VIN = 6 V		6.5	10	mA
	+VIN = 36 V		9.5	15	mA
	Logic Disable = 2 V (UCx832 only)		3.3		mA
Reference Section					
Output Voltage (Note 3)	TJ = 25°C, IDRIVER = 10 mA	1.98	2.00	2.02	V
	over temperature, IDRIVER = 10 mA	1.96	2.00	2.04	V
Load Regulation (UCx832 only)	Io = 0 to 10 m	-10	-5.0		mV
Line Regulation	+VIN = 4.5 V to 36 V, IDRIVER = 10 m		0.033	0.5	mV/V
Under-Voltage Lockout Threshold			3.6	4.5	V
Logic Disable Input (UCx832 only)					
Threshold Voltage		1.3	1.4	1.5	V
Input Bias Current	Logic Disable = 0 V	-5.0	-1.0		μA
Current Sense Section					
Comparator Offset		95	100	105	mV
	Over Temperature	93	100	107	mV
Amplifier Offset (UCx833 only)		110	135	170	mV
Amplifier Offset (UCx832 only)	VADJ = Open	110	135	170	mV
	VADJ = 1 V	180	235	290	mV
	VADJ = 0 V	250	305	360	mV
Input Bias Current	VCM = +VIN	65	100	135	μA
Input Offset Current (UCx832 only)	VCM = +VIN	-10		10	μA
Amplifier CMRR (UCx832 only)	VCM = 4.1 V to +VIN + 0.3		80		dB
Transconductance	ICOMP = ±100 μA		6		mS
VADJ Input Current (UCx832 only)	VADJ = 0V	-10	-1		μA
Timer					
Inactive Leakage Current	C/S(+) = C/S(-) = +VIN; TRC pin = 2 V		0.25	1.0	μA
Active Pullup Current	C/S(+) = +VIN, C/S(-) = +VIN - 0.4V; TRC pin = 0 V	-345	-270	-175	μA
Duty Ratio (note 4)	ontime/period, RT = 200k, CT = 0.27μF		4.8		%
Period (notes 4,5)	ontime + offtime, RT = 200k, CT = 0.27μF		36		ms
Upper Trip Threshold (Vu)			1.8		V
Lower Trip Threshold (VI)			0.9		V
Trip Threshold Ratio	Vu/VI		2.0		V/V
Error Amplifier					
Input Offset Voltage (UCx832 only)	VCM = VCOMP = 2 V	-8.0		8.0	mV
Input Bias Current	VCM = VCOMP = 2 V	-4.5	-1.1		μA
Input Offset Current (UCx832 only)	VCM = VCOMP = 2 V	-1.5		1.5	μA
AVOL	VCOMP = 1 V to 13 V	50	70		dB
CMRR (UCx832 only)	VCM = 0V to +VIN - 3 V	60	80		dB
PSRR (UCx832 only)	VCM = 2 V, +VIN = 4.5 V to 36		90		dB
Transconductance	ICOMP = ±10 μA		43		mS
VOH	ICOMP = 0, Volts below +VIN		.95	1.3	V
VOL	ICOMP = 0		.45	0.7	V
IOH	VCOMP = 2 V	-700	-500	-100	μA

ELECTRICAL CHARACTERISTICS (cont.)

Unless otherwise stated, specifications hold for $T_A = 0^{\circ}\text{C}$ to 70°C for the UC3832/3, -40°C to 85°C for the UC2832/3, $+V_{IN} = 15\text{ V}$, Driver sink = $+V_{IN}$, C/S(+) voltage = $+V_{IN}$. $T_A = T_J$.

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Error Amplifier (cont.)					
IOL	$V_{COMP} = 2\text{ V}$, C/S(-) = $+V_{IN}$	100	500	700	μA
	$V_{COMP} = 2\text{ V}$, C/S(-) = $+V_{IN} - 0.4\text{ V}$	2	6		mA
Driver					
Maximum Current	Driver Limit & Source pins common; $T_J = 25^{\circ}\text{C}$	200	300	400	mA
	Over Temperature	100	300	450	mA
Limiting Voltage (UCx832 only)	Driver Limit to Source voltage at current limit, $I_{SOURCE} = -10\text{ mA}$; $T_J = 25^{\circ}\text{C}$ (Note 6)		.72		V
Internal Current Sense Resistance	$T_J = 25^{\circ}\text{C}$ (Note 6)		2.4		Ω
Pull-Up Current at Driver Sink	Compensation/Shutdown = 0.4 V ; Driver Sink = $+V_{IN} - 1\text{ V}$	-800	-300	-100	μA
	Compensation/Shutdown = 0.4 V , $+V_{IN} = 36\text{ V}$; Driver Sink = 35 V	-1000	-300	-75	μA
Pull-Down Current at Driver Source	Compensation/Shutdown = 0.4 V ; Driver Source = 1 V	150	300	700	μA
Saturation Voltage Sink to Source	Driver Source = 0 V ; Driver Current = 100 mA		1.5		V
Maximum Source Voltage	Driver Sink = $+V_{IN}$, Driver Current = 100 mA Volts below $+V_{IN}$		3.0		V
UVLO Sink Leakage	$+V_{IN} = \text{C/S}(+) = \text{C/S}(-) = 2.5\text{ V}$, Driver Sink = 15 V , Driver Source = 0 V , $T_A = 25^{\circ}\text{C}$		25		μA
Maximum Reverse Source Voltage	Compensation/Shutdown = 0 V ; $I_{SOURCE} = 100\text{ }\mu\text{A}$, $+V_{IN} = 3\text{ V}$		1.6		V
Thermal Shutdown			160		$^{\circ}\text{C}$

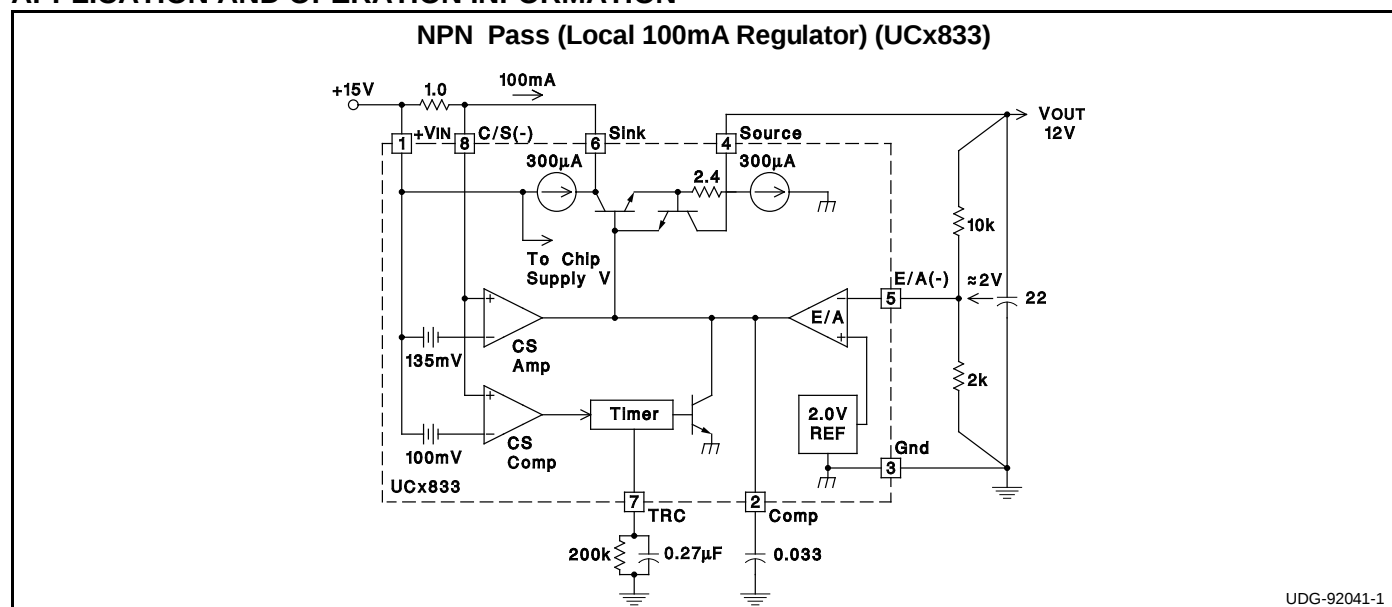
Note 3: On the UCx833 this voltage is defined as the regulating level at the error amplifier inverting input, with the error amplifier driving V_{SOURCE} to 2 V .

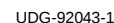
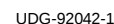
Note 4: These parameters are first-order supply-independent, however both may vary with supply for $+V_{IN}$ less than about 4 V . This supply variation will cause a slight change in the timer period and duty cycle, although a high off-time/on-time ratio will be maintained.

Note 5: With recommended R_T value of 200 k , $T_{OFF} \approx R_T C_T \cdot \ln(V_u/V_l) \pm 10\%$.

Note 6: The internal current limiting voltage has a temperature dependence of approximately $-2.0\text{ mV}/^{\circ}\text{C}$, or $-2800\text{ ppm}/^{\circ}\text{C}$. The internal $2.4\text{ }\Omega$ sense resistor has a temperature dependence of approximately $+1500\text{ ppm}/^{\circ}\text{C}$.

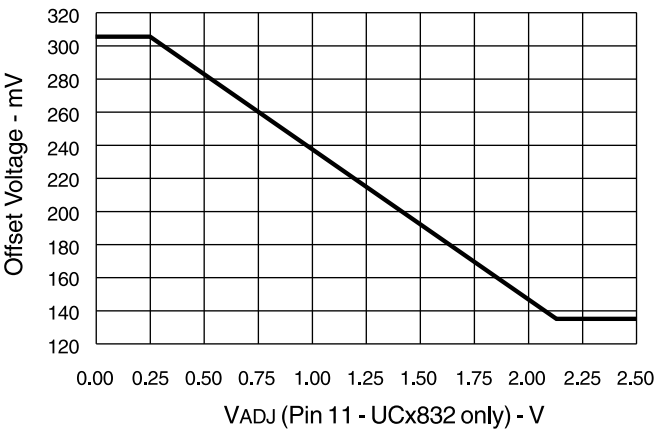
APPLICATION AND OPERATION INFORMATION



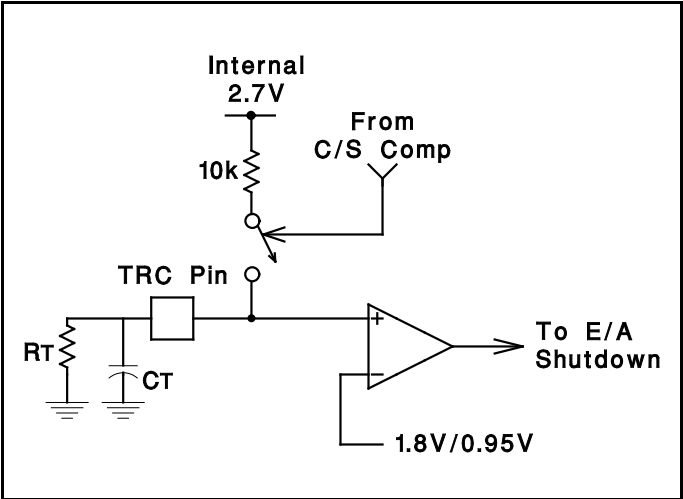

$$C_{MAX} = \frac{T_{ON}}{R_L} \cdot \frac{1}{\ln \left[\left(1 - \frac{V_{OUT}}{K \cdot I_{TH} \cdot R_I} \right)^{-1} \right]}$$

APPLICATION AND OPERATION INFORMATION (cont.)

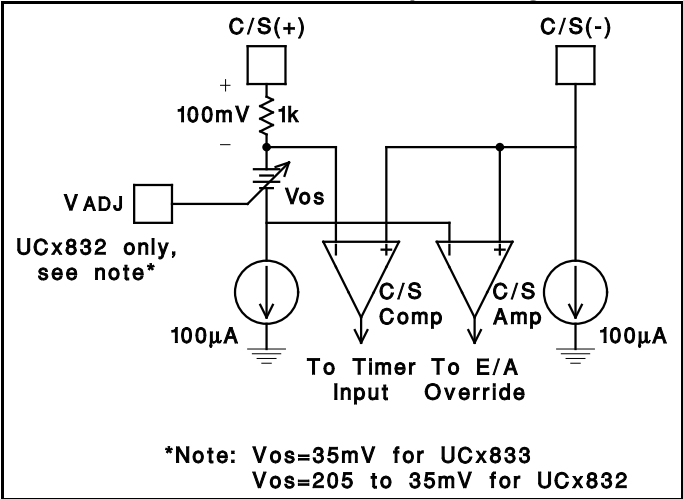
Current Sense Amplifier Offset Voltage vs V_{ADJ}



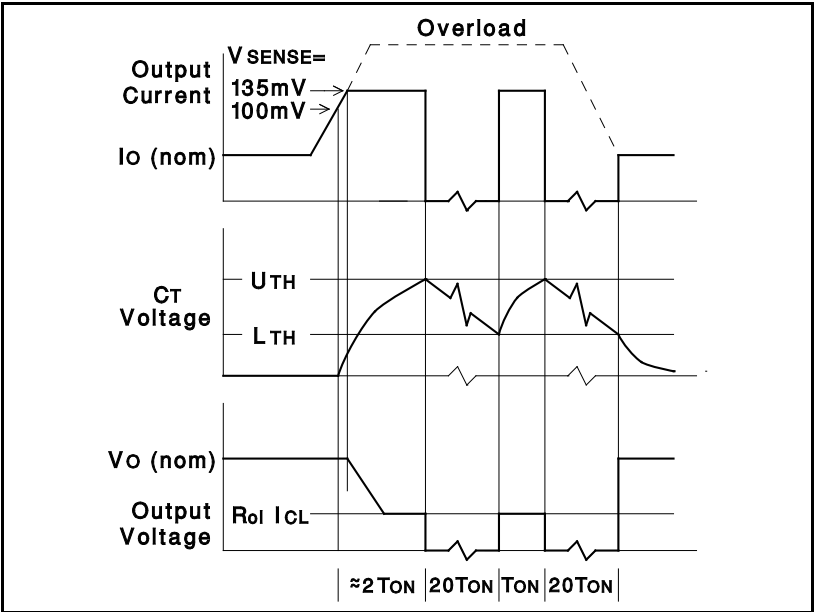
UCx832/33 Timer Function



UCx832/33 Current Sense Input Configuration



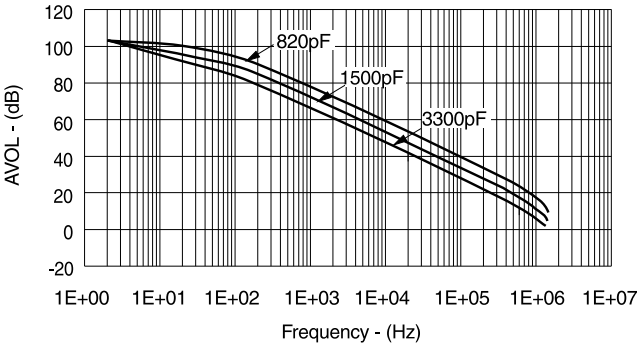
Load current, timing capacitor voltage, and output voltage of the regulator under fault conditions.



APPLICATION AND OPERATION INFORMATION (cont.)

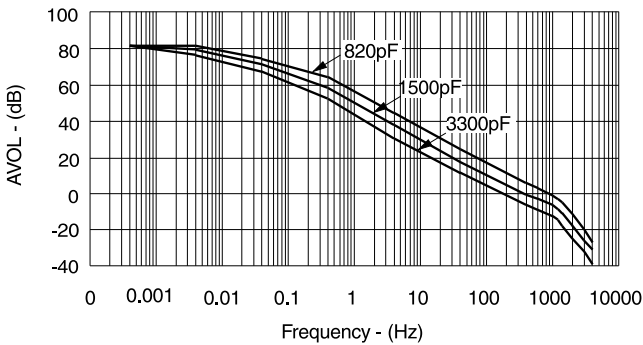
UCx832 Error Amplifier

AVOL vs Frequency and CC



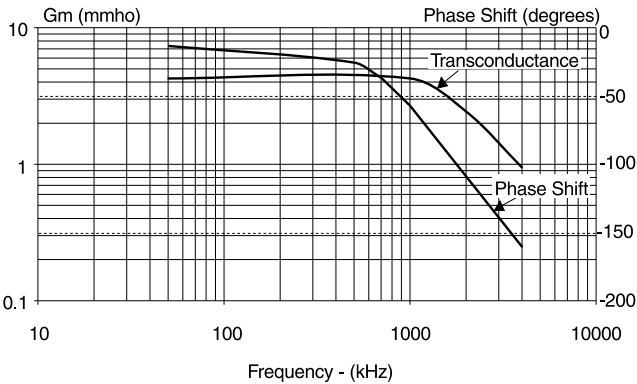
UCx832 Current Sense Amplifier

AVOL vs Frequency and CC



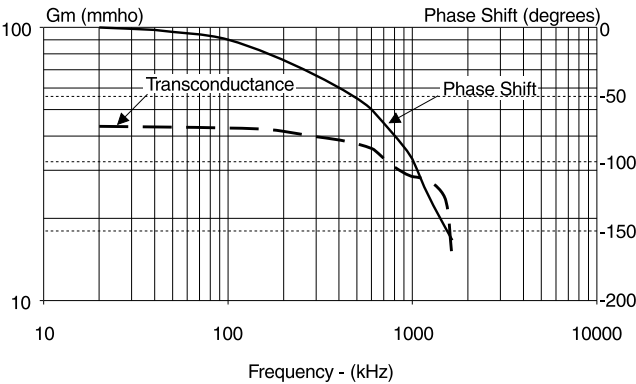
UCx832 Error Amplifier

Transconductance and Phase vs Frequency



UCx832 Current Sense Amplifier

Transconductance and Phase vs Frequency



PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
5962-9326501M2A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 9326501M2A UC1832L/ 883B
5962-9326501MCA	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9326501MC A UC1832J/883B
5962-9326501V2A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 9326501V2A UC1832L QMLV
5962-9326501V2A.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 9326501V2A UC1832L QMLV
5962-9326501VCA	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9326501VC A UC1832JQMLV
5962-9326501VCA.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9326501VC A UC1832JQMLV
UC1832J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	UC1832J
UC1832J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	UC1832J
UC1832J883B	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9326501MC A UC1832J/883B
UC1832J883B.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9326501MC A UC1832J/883B
UC1832L883B	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 9326501M2A UC1832L/ 883B

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
UC1832L883B.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9326501M2A UC1832L/ 883B
UC2832DW	Active	Production	SOIC (DW) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2832DW
UC2832DW.A	Active	Production	SOIC (DW) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2832DW
UC2833DW	Active	Production	SOIC (DW) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UC2833DW
UC2833DW.A	Active	Production	SOIC (DW) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UC2833DW
UC2833DWG4	Active	Production	SOIC (DW) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UC2833DW
UC2833DWTR	Active	Production	SOIC (DW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UC2833DW
UC2833DWTR.A	Active	Production	SOIC (DW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UC2833DW
UC3832DW	Active	Production	SOIC (DW) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3832DW
UC3832DW.A	Active	Production	SOIC (DW) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3832DW
UC3833DW	Active	Production	SOIC (DW) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3833DW
UC3833DW.A	Active	Production	SOIC (DW) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3833DW
UC3833DWTR	Active	Production	SOIC (DW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3833DW
UC3833DWTR.A	Active	Production	SOIC (DW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3833DW

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

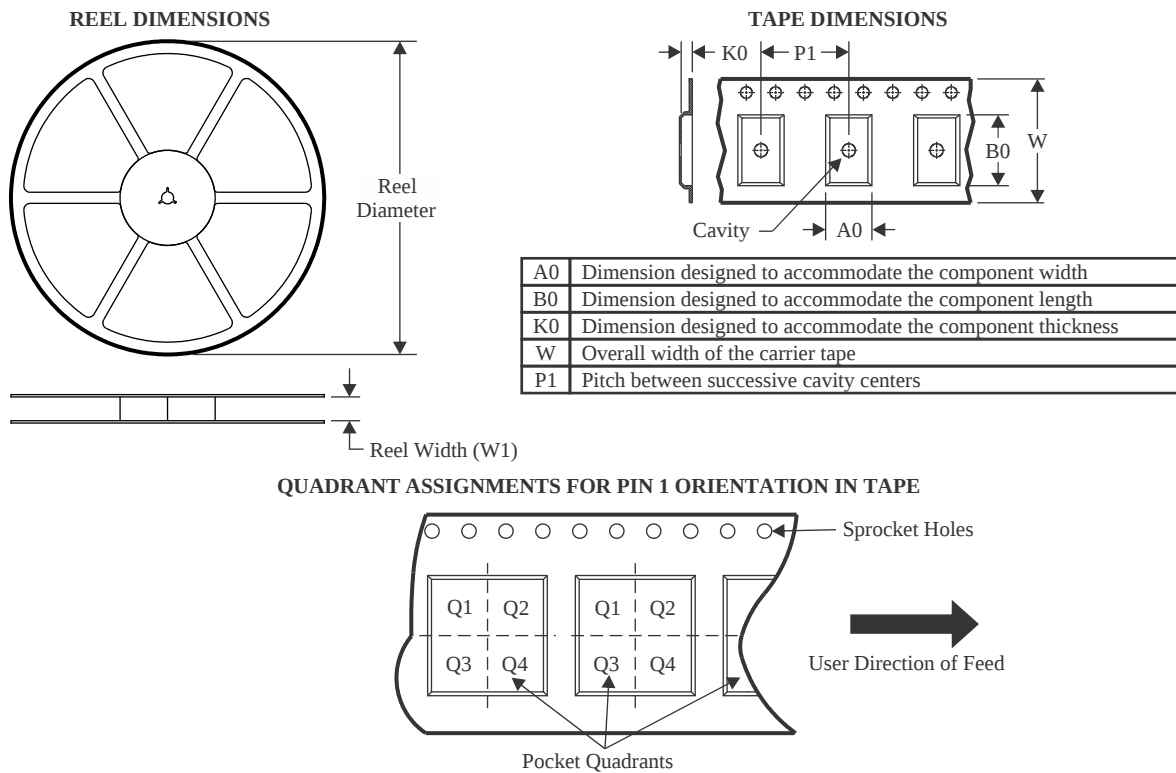
OTHER QUALIFIED VERSIONS OF UC1832, UC1832-SP, UC2832, UC3832 :

- Catalog : [UC3832](#), [UC1832](#)
- Enhanced Product : [UC2832-EP](#)
- Military : [UC1832](#)
- Space : [UC1832-SP](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Enhanced Product - Supports Defense, Aerospace and Medical Applications
- Military - QML certified for Military and Defense Applications
- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

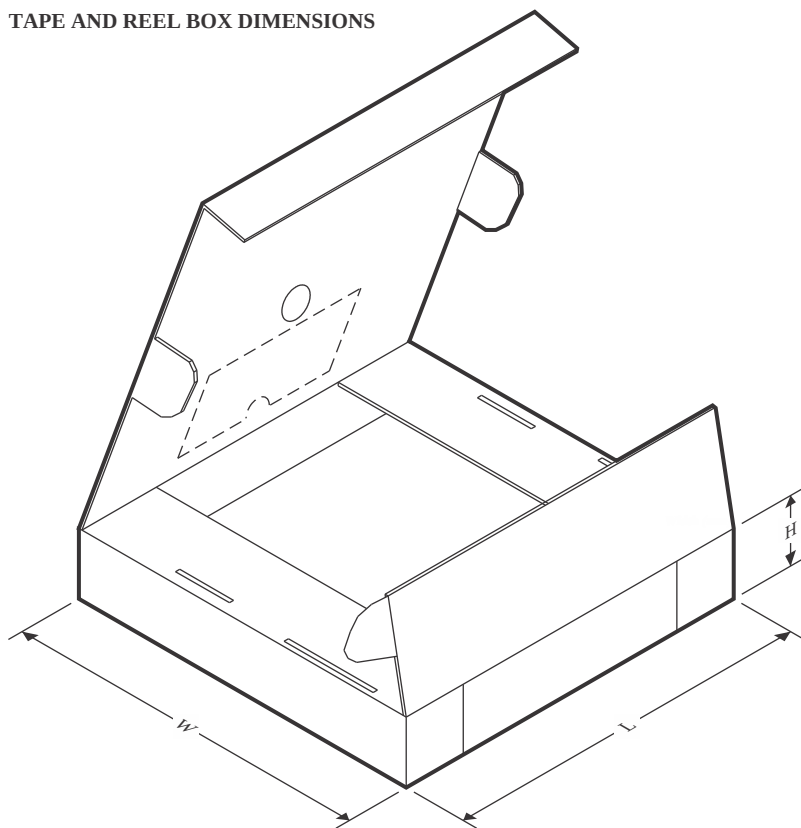
TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UC2833DWTR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1
UC3833DWTR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
UC2833DWTR	SOIC	DW	16	2000	353.0	353.0	32.0
UC3833DWTR	SOIC	DW	16	2000	353.0	353.0	32.0

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
5962-9326501M2A	FK	LCCC	20	55	506.98	12.06	2030	NA
5962-9326501V2A	FK	LCCC	20	55	506.98	12.06	2030	NA
5962-9326501V2A.A	FK	LCCC	20	55	506.98	12.06	2030	NA
UC1832L883B	FK	LCCC	20	55	506.98	12.06	2030	NA
UC1832L883B.A	FK	LCCC	20	55	506.98	12.06	2030	NA
UC2832DW	DW	SOIC	16	40	507	12.83	5080	6.6
UC2832DW.A	DW	SOIC	16	40	507	12.83	5080	6.6
UC2833DW	DW	SOIC	16	40	507	12.83	5080	6.6
UC2833DW.A	DW	SOIC	16	40	507	12.83	5080	6.6
UC2833DWG4	DW	SOIC	16	40	507	12.83	5080	6.6
UC3832DW	DW	SOIC	16	40	507	12.83	5080	6.6
UC3832DW.A	DW	SOIC	16	40	507	12.83	5080	6.6
UC3833DW	DW	SOIC	16	40	507	12.83	5080	6.6
UC3833DW.A	DW	SOIC	16	40	507	12.83	5080	6.6

GENERIC PACKAGE VIEW

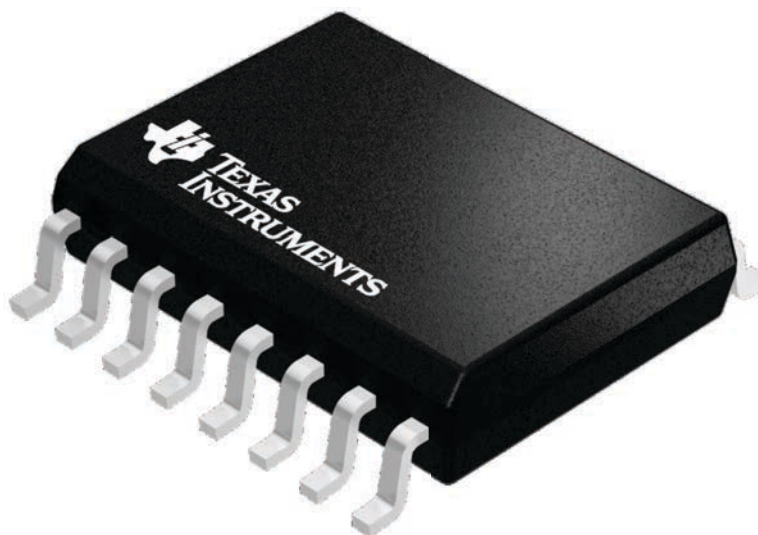
DW 16

SOIC - 2.65 mm max height

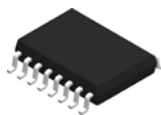
7.5 x 10.3, 1.27 mm pitch

SMALL OUTLINE INTEGRATED CIRCUIT

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.



4224780/A

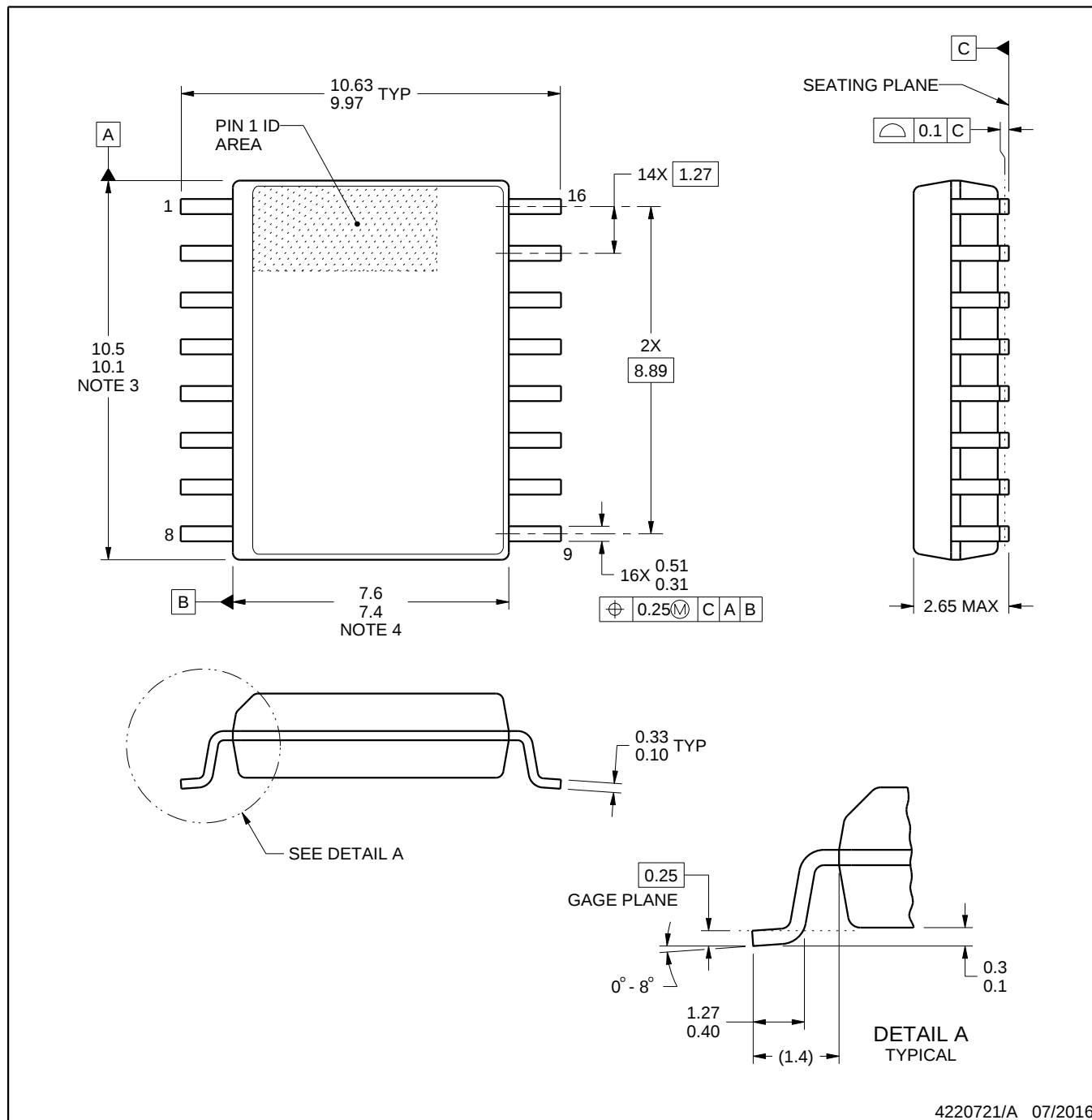


DW0016A

PACKAGE OUTLINE

SOIC - 2.65 mm max height

SOIC



4220721/A 07/2016

NOTES:

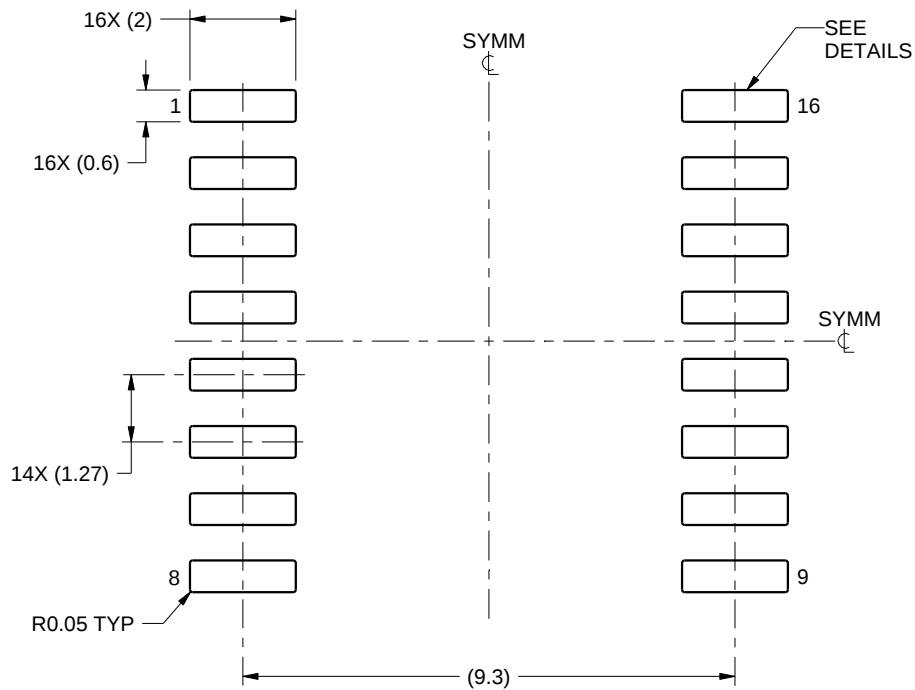
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.
5. Reference JEDEC registration MS-013.

EXAMPLE BOARD LAYOUT

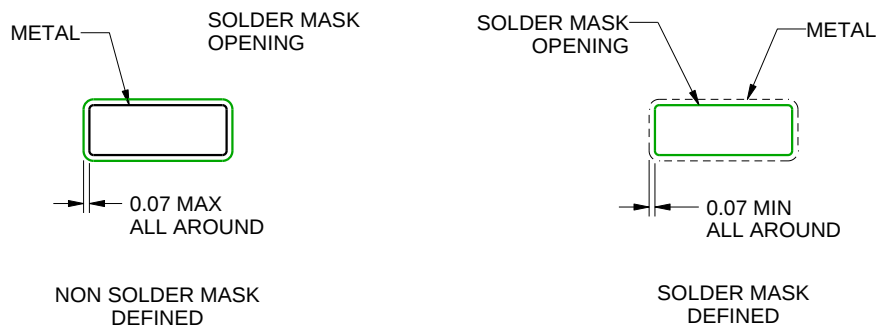
DW0016A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE
SCALE:7X



SOLDER MASK DETAILS

4220721/A 07/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

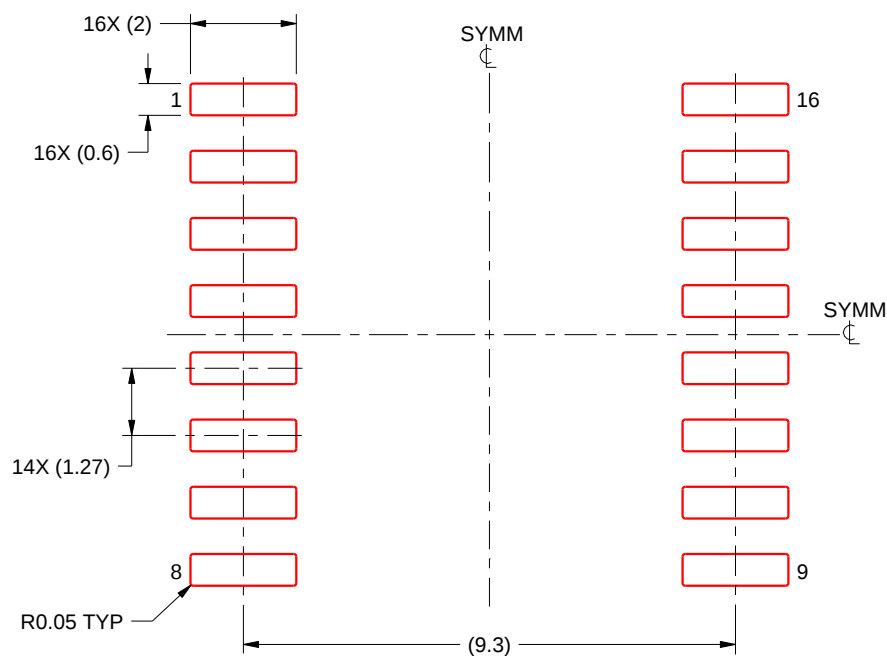
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DW0016A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:7X

4220721/A 07/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

GENERIC PACKAGE VIEW

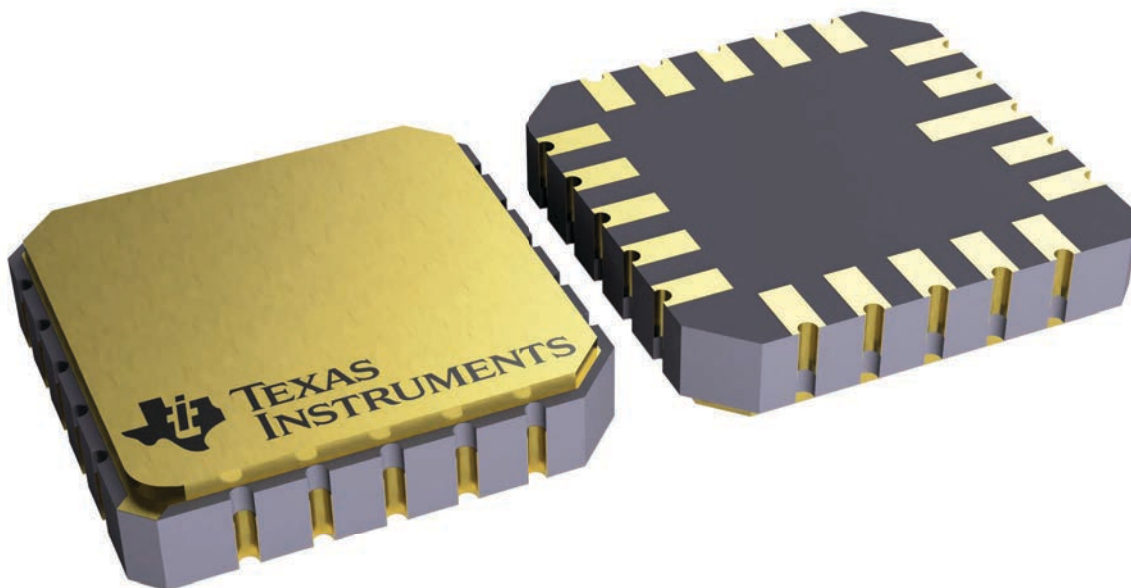
FK 20

LCCC - 2.03 mm max height

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.



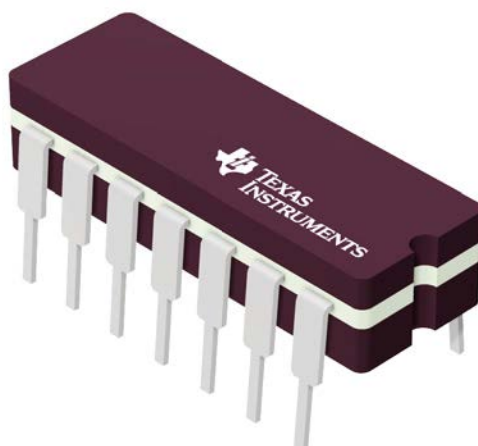
4229370VA\

J 14

GENERIC PACKAGE VIEW

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

4040083-5/G

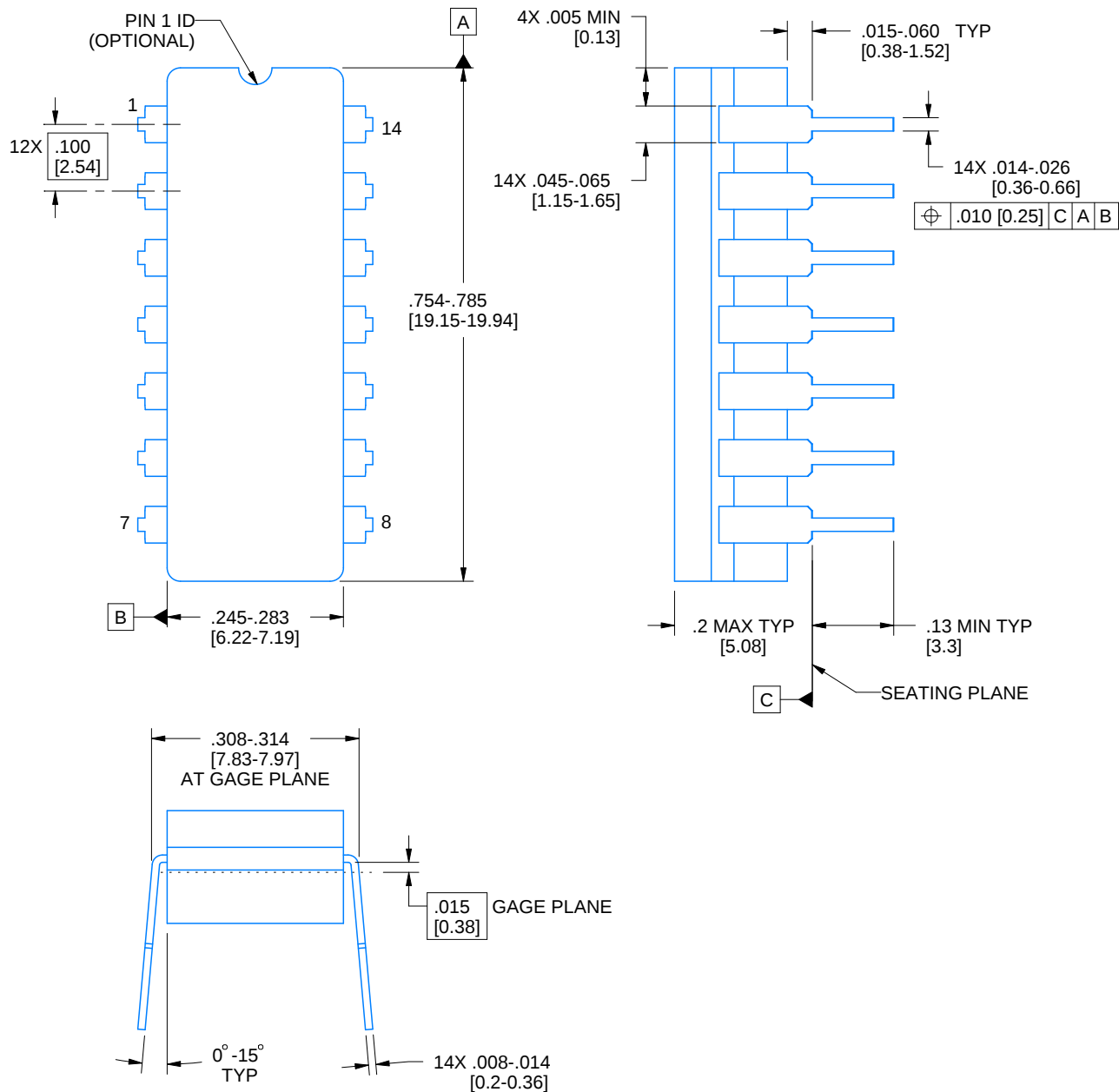


J0014A

PACKAGE OUTLINE

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



4214771/A 05/2017

NOTES:

1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package is hermetically sealed with a ceramic lid using glass frit.
4. Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
5. Falls within MIL-STD-1835 and GDIP1-T14.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#), [TI's General Quality Guidelines](#), or other applicable terms available either on [ti.com](#) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2026, Texas Instruments Incorporated

Last updated 10/2025